Empowering the Electronics Industry A Power Technology Roadmap

Power Sources Manufacturers Association (PSMA)

2017 PTR Co-Chairs:

Dhaval Dalal, ON Semiconductor

Conor Quinn, Artesyn Embedded Technologies

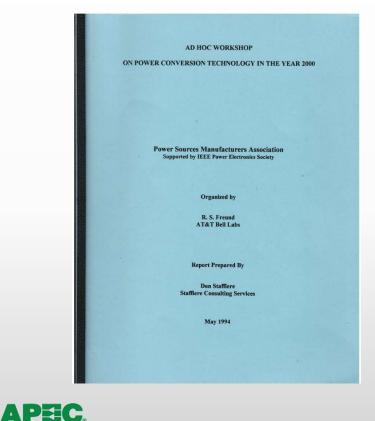




Technology Roadmap, as assessed by our Industry ...



Power Technology Roadmap since 1994



| 1994 | 2017 |
|--------------|--------------|
| Methodology | |
| 1 day | 18 months |
| Ad-hoc | Scheduled |
| Participants | |
| 18 | 82+ |
| Focus | |
| Product | Product |
| | Applications |
| | Components |
| Pages | |
| 21 | 537 |



TECHNOLOGY ROADMAP

Organizing Committee Chairs Dhout B. Date ON Servicenshiettor

Segment Leaders

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Arnold Alderman Anogenesis Inc. Non-Isolated Dc-Dc Converters

2009, 2011, 2013, 2015, 2017 Stephen (Niver Novitas Semiconductor Ac-Dc External Power Supplies 2017

isolated Dc-Dc Converters 2013, 2015 Brian Zahnstecher PowerRox Ac-Dc Front-End Power Supplies 2015, 2017

Joff Milles Texas Instruments Non-balated Dc-Dc Converters 2017

John Wiggenhorn ON Semiconductor Ac-Dc External Power Supplies 2013, 2015, 2017

Alain Chapois Bel Power Solutions Ac-Dc Front-End Power Supplies 2017



Outline

- Who we are and what we do
- What remains consistent with previous roadmaps
- What has changed in this roadmap cycle





Who are we and what do we do ?



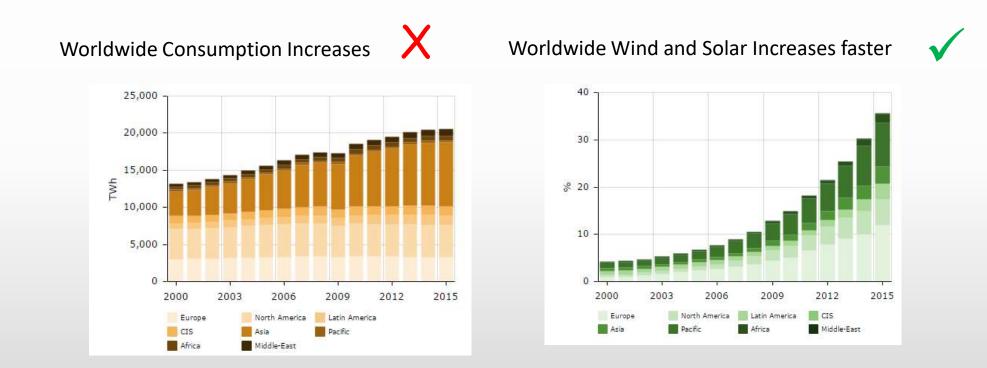




What do we really do? Power stuff <u>efficiently</u>



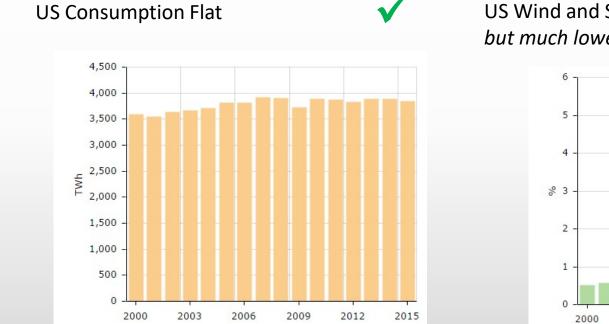
Electric Energy Consumption Patterns



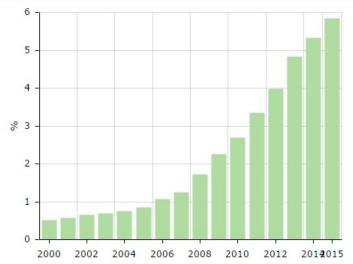




Electric Energy Consumption Patterns



US Wind and Solar Increases faster but much lower than worldwide penetration



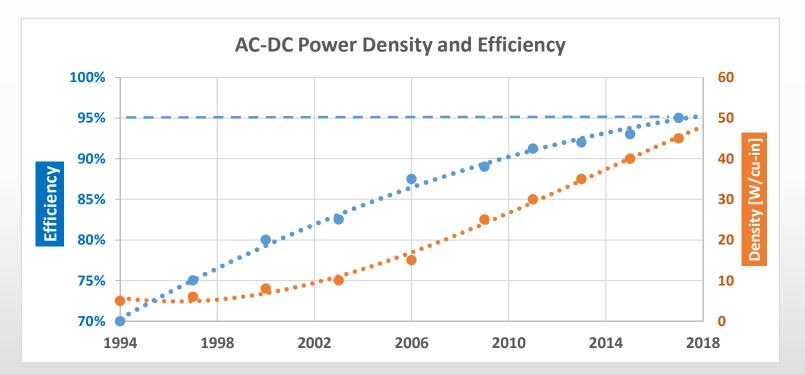


Source: https://yearbook.enerdata.net/#energy-consumption-data.html



X

We've come a long way ...



While cost has fallen by a factor of 5 or 10 !





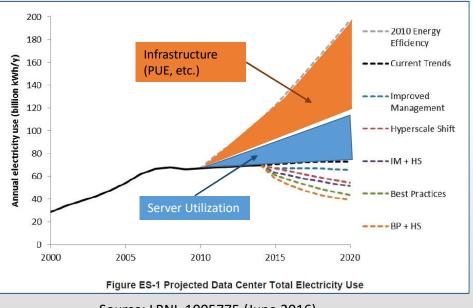
Source: PSMA Roadmap Data and Industry Datasheets

Datacenters: Successfully bending the curve



~ 70 billion kWhrs annually in US~ 2% of US Electricity Consumption

Electricity usage slowed to 4% per year



Source: LBNL-1005775 (June 2016)





Need to keep bending the curve



- Energy Usage in Legal Cultivation
 - 2012: 1.0% of US Electricity Usage
 - 2016: 2.0% in Denver, CO *Compare with Datacenters at 1.8%*
- Will only continue to grow
 - In 2012, cultivation was legal in 15 states plus District of Columbia
 - In 2016, 28 states had legalized in some form



Sources:

: Evan Mills, Elsevier Energy Policy 46 (2012) 58-67 http://www.theguardian.com/us-news/2016/feb/27/marijuana-industry-huge-energy-footprint



Roadmap Methodology

• The cube

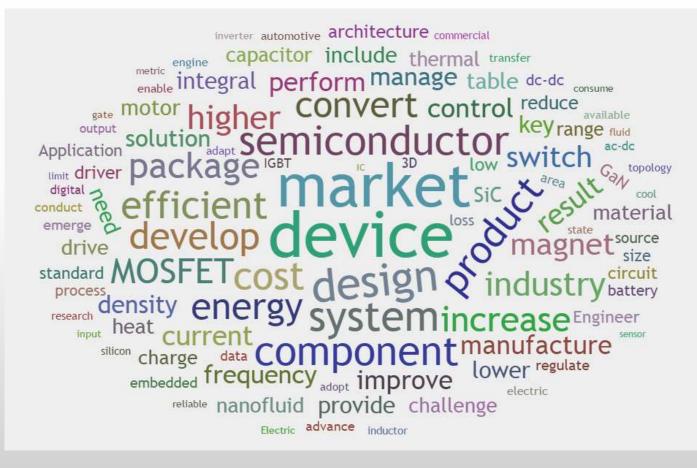


- Webinar Series
- Trend Working Groups / Leaders
 - Power Supply and Converters
 - Applications
 - Components
 - Emerging Technologies
- Online Survey
- Report Consolidation and Editing





What's hot?







Takeaway: Shift in Perceptions

Nothing has changed ! Technology Responsive

- Commoditization of AC-DC Power Supplies and DC-DC Converters continues
- Smaller, Faster, Cheaper Technology Treadmill

Everything is different ! Technology Shaping

- We are now shaping the future and the public are (somewhat) familiar with our products
- Opportunities for selfpromotion, should we want to





?

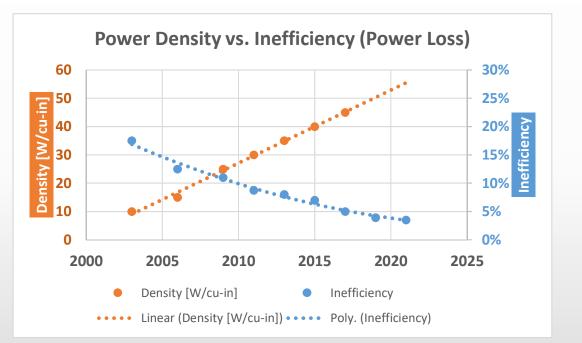
- SMALLER
 - Power Density Trends
- FASTER

- CHEAPER
 - Cost and commoditization of the traditional products covered





- SMALLER
 - Power Density Trends
 - Enabled by significant reduction in power losses
 - Not approaching the limits





NOTE: This has been mostly achieved without increases in switching frequency



Source: PSMA Roadmap Data and Industry Datasheets

• CHEAPER



• Cost and commoditization in <u>all 4</u> Power Supply and Converter sections

| Parameter/Metric | 2019 Est. (PTR 2015) | 2017 | 20 <mark>1</mark> 9 | 2021 | |
|--|-------------------------|-----------------------|-----------------------|-----------------------|--|
| Key Design Goal (In Order of Importance): (Answer those with which you are familiar.) Score 1 to 4 where 1 = Most Important and 4 = Least Important | | 1 = Most 4 = Least | 1 = Most 4 = Least | 1 = Most 4 = Least | |
| Server & Storage | | 8 | 5 | | |
| Efficiency | 3 | 3 | 3 | 3 | |
| Cost | 1 | 1 | 1 | (1) | |
| Power Density | 4 | 4 | 4 | 4 | |
| Reliability | 2 | 2 | 2 | 2 | |

Demand for isolated dc-dc converter modules continues to be dominated by applications in the converged computing and telecommunications market segment as the integration of voice and data communication capabilities into the internet backbone is almost complete steep commoditization trend

and switching losses. The semiconductor industry is racing to have the most cost effective solution. The adoption will hinge (as usual) on the cost vs. performance tradeoff related to the external pressures of the market. SiC and GaN products are n if is a specific cost of the external pressure of the infinite cost vs. performance tradeoff related to the external pressure of the market.

the most cost effective solution

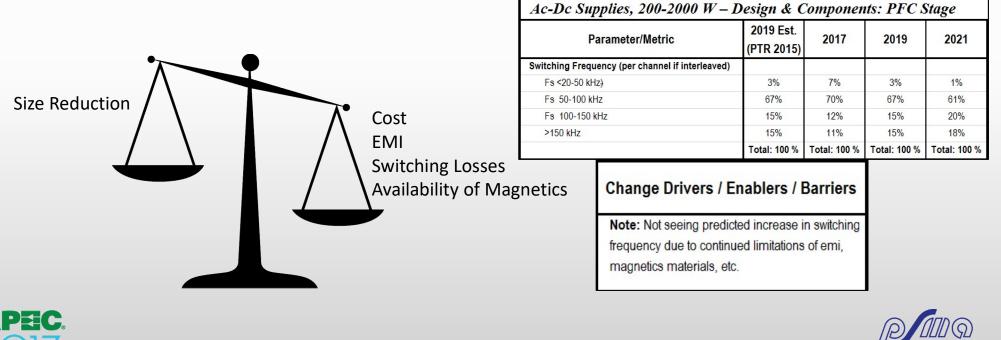
| Estimated Industry Price Trend Compared to Today | % of Respondents in last report | Select One |
|--|------------------------------------|------------|
| -10% or more | 2.3% | 1.0% |
| Approx5% | 91.7% | 45.0% |
| Same | 5.0% | 43.0% |
| Approx. +5% | 0.7% | 11.0% |
| +10% or more | 0.3% | 0.0% |
| | Total: 100 % | 100% |

Expectation of across the board price reduction is tamed greatly when compared to past





FASTER ... Higher Switching Frequency ?

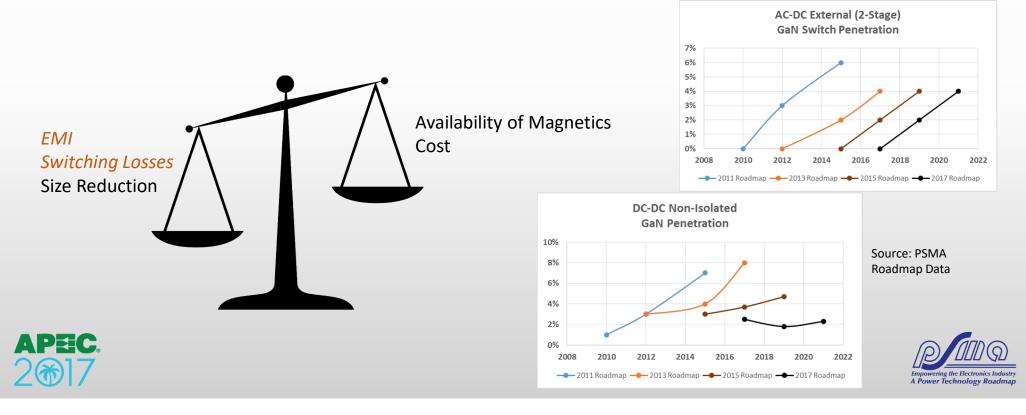






Or has something changed ?

• FASTER ... Wide Bandgap devices begin to shift the discussion



What still needs to change ?

- Magnetics, Magnetics, Magnetics
- Industry has acknowledged the limitations
- Included in the report
 - New materials, some from the RF domain
 - Industry initiatives to improve characterization
 - New techniques and processes
 - Appropriate topologies

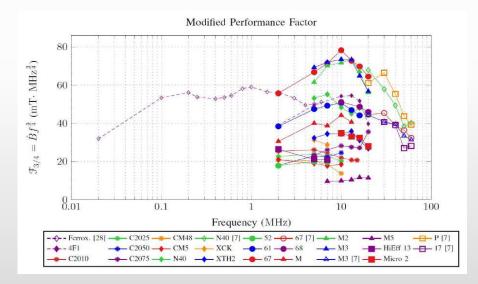






Magnetics Technology Examples

Core Materials for Multi-MHz



Thin Film Magnetics





Source: PSMA Magnetics Workshop 2016, David Perrault MIT

Source: Noah Sturcken, Ferric Inc.



Everything is Different

Noticeable change in tone from the power conversion industry from Technology Responsive to <u>now Shaping Technology</u>

- From Very Low Power to High Power
- From Energy Generation and Distribution to Transportation
- And the Component and Packaging Technologies that enable these





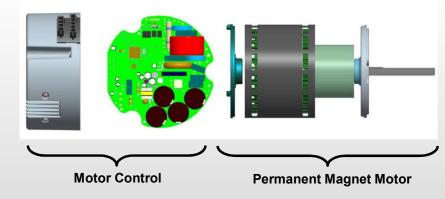
Shaping New and Improved Applications

Energy Harvesting

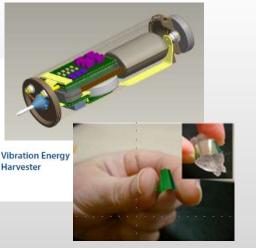
- As low as μW
- Kinetic, PV, Temperature, Humidity
- Sensors to Implantables

Indoor Climate Control

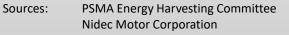
- Smart Controls
- Energy-saving Variable Speed Drive













Shaping Electrification

Generation and Distribution

- PV and Wind
- Energy Storage Challenges

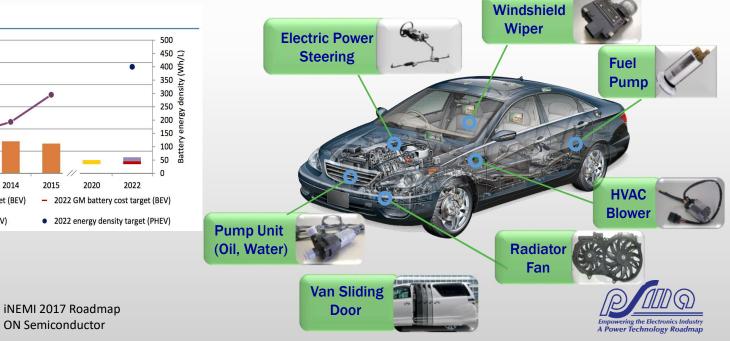
1 200 500 450 🖵 Battlery cost (USD/kWh) 009 000 000 000 000 000 000 000 400 X 350 300 250 200 150 100 200 50 0 0 2008 2009 2010 2011 2012 2013 2014 2015 2020 2022 US DOE battery cost (PHEV) 2020 Tesla battery cost target (BEV) 2022 GM battery cost target (BEV) - 2022 battery cost target (PHEV) 2022 energy density target (PHEV)

Sources:

Evolution of battery energy density and cost

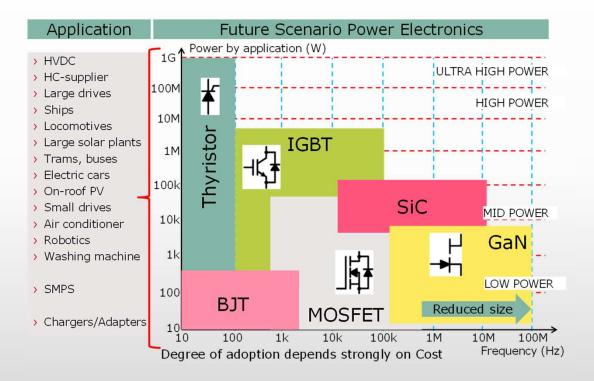
Transportation

- Electric Vehicles
- Electrified Vehicles





Component Technologies



Report covers

- IGBTs
- MOSFETs
- GaN
- SiC
- Controllers
- Passives

Detailed discussion of

- Market Drivers
- Key Metrics
- Trends
- Challenges

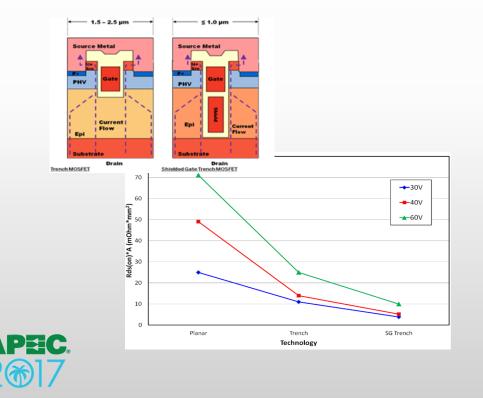




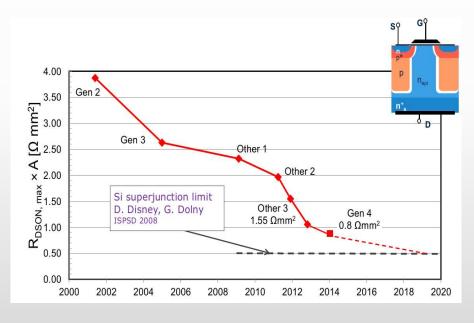
Source: Infineon Technologies

Component Technologies

Low Voltage FET Improvements



High Voltage FET Trends

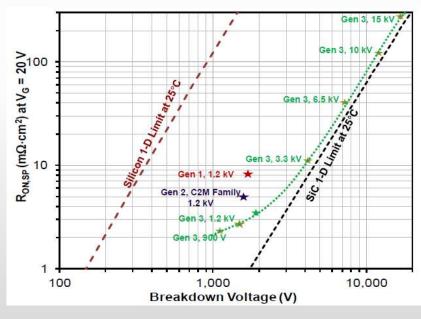




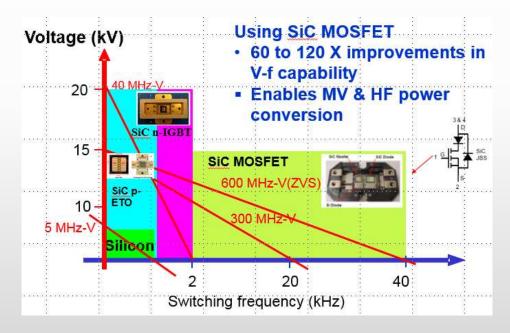
Source: PSMA 2017 Roadmap

Component Technologies

SiC Trends



SiC for "Medium" Voltage



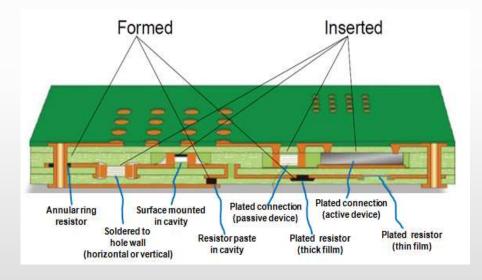


Sources: Wolfspeed NC State



Emerging Technologies

Embedded Substrate



Nanofluids enhance Cooling





| Type of Nanoparticle | Thermal Conductivity of Particle W/(m-K) | Size of Particle in Solution* | Amount of Solution* | Price of Unit (USD)** |
|---|---|----------------------------------|---------------------|--------------------------|
| Alumina (Al ₂ O ₃) | 30 | 30-60 nm | 100.0 mL | \$183.50 |
| Copper Oxide (CuO) | 401 | <50 nm | 25.0 g*** | \$73.10 |
| Gold (Au) | 310 | 10 nm | 25.0 mL | \$338.00-\$362.00 |
| Gold (Au) with Silica Coating | N/A | 10 nm | 5.0 mL | \$318.50 |
| Iron Oxide (Fe ₂ O3) | 0.58 | 30 nm | 5.0 mL | \$240.00 |
| Silver (Ag) | 429 | 20 nm | 25 mL | \$114.50 |
| Titanium Oxide (TiO2) | 22 | 21 nm | 100.0 g | 199.50 |



Sources:

PSMA Packaging Committee Advanced Thermal Solutions, Inc.



Quantitative Tables

| | | | | | | | | Boost Switch GaN Penetration | |
|--|-------------------------|-------------------------|-------------------------|--------------|--------------|--------------|--|--|--|
| I. Dc-Dc Converters, Isolated – General Requirements II | | | | | | | 20% | | |
| Parameter/Metric For each PARAMETER, identify the expected change in usage in your industry compared today's level of usage. | 2015 Est. (PTR 2011) | 2017 Est. (PTR 2013) | 2019 Est. (PTR 2015) | 2017 | 2019 | 2021 | Change Drivers / Enablers Barriers | 15% | |
| Output Voltage Regulation (%) | | | | | | | Drivers: Trade-off of efficiency vs. p | 5% | |
| Totally Unregulated (DCTransformer) | 18% | Same | 15% | 24 % | 22% | 33 % | density | | |
| Semi-Regulated (Total Regulation Band ±2 % To ±10 %) | 4% | More | 32% | 27 % | 26% | 24 % | Enablers: Flexibility of down stream | 0% | |
| Well Regulated (Total Regulation Band ±2 % Or Better) | 78% | Same | 53% | 49% | 52% | 43 % | regulation | 2008 2010 2012 2014 2016 2018 2020 20 | |
| | Total: 100 % | | | Total: 100 % | Total: 100 % | Total: 100 % | Barriers: Confusion created by IP I | 2011 Roadmap 2013 Roadmap 2015 Roadmap 2017 Roadmap | |
| Expected Efficiency - most economical (Eff%) | | | | | | | | | |
| 48 Vin - 3.3 Vout (regulated) | 93% | Х | 91% | 85% | 86% | 87 % | | | |
| 48 Vin - 12 Vout (regulated) | 94% | Х | 94% | 89 % | 90% | 94 % | Wide breadth of responses; entry represents averaged response | | |
| 48 Vin - 12 Vout (un regulated) | | | 95% | 91 % | 93% | 94 % | | | |
| 380 Vin - 12 Vout (regulated) | | | 92% | 90 % | 90% | 92 % | | AC-DC External (1-Stage, <15W) GaN Switch Penetration | |
| 380 Vin - 12 Vout (un regulated) | | | 94% | 89 % | 90% | 92 % | | | |
| Expected Efficiency - most advanced (Eff%) | | | | | | | | 25% | |
| 48 Vin - 3.3 Vout (regulated) | 97% | Х | 94% | 88 % | 89% | 91 % | | 20% | |
| 48 Vin - 12 Vout (regulated) | 98.0% | 98.0% | 96% | 92 % | 94% | 97 % | Wide breadth ofresponses: en trv | 20% | |
| 48 Vin - 12 Vout (un regulated) | | | 98% | 92 % | 95% | 95 % | represents a veraged response | 15% | |
| 380 Vin - 12 Vout (regulated) | | | 97% | 92 % | 96% | 96 % | | 10% | |
| 380 Vin - 12 Vout (un regulated) | | | 98% | 92 % | 96% | 96 % | | | |
| Power Management Interface Technology (%) | | | | | | | | 5% | |
| None | 80% | Same | 30% | 51% | 44% | 37% | Drivers: Need for more control t | 0% | |
| 12C | 10% | Same | 27% | 13% | 20% | 23% | improve overall system efficienc | | |
| PMBus | | | e 39% | 16 % | 30% | 40 % | Enablers: digital control easily adds | | |
| Other | Trace | More | 4% | 20 % | 6% | 0% | capability for communication sinterfac | Ce | |
| | Total: 90 % | | | Total: 100 % | Total: 100 % | Total: 100 % | | | |



Sources: PSMA Roadmap Data



AC-DC Front-End

Print Version and USB Stick

2017 PSMA POWER TECHNOLOGY ROADMAP

wering the Electronics Industry

Organizing Committee Chairs

Segment Leaders

Dhout B. David

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App Plan ON Semiconductor Application Trends 2015, 2017

Vittorio Crisafuli ON Semiconductor Singunent Technologies 2017

Brian Narveson Narveson Innovative Consulting Emerging Technologies 2015, 2017

Cahit Gragin Influeon Technologies Non-isolated Dc-Dc Converters 2015, 2017

Annold Alderman Anagemenis Inc. Non-Isalated Dc-Dc Converters 2009, 2011, 2013, 2015, 2017

Stephen Oliver Novitas Semiconductor Ac-Dc External Pawer Supplies 2017 Isolated Dc Dc Converters 2013, 2015

Brian Zahnstecher PowerRox Ac-De Front-End Power Supplies 2015, 2017 Tim McDonakt Infineon Technologies Component Technologies 2017

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John Wiggenhorn ON Semiconductor Ac-Dc External Power Sapplies 2013, 2015, 2017

Alain Chapuis Bel Power Solutions Ac-Dc Front-End Power Supplies 2017



USB Stick includes 13 Webinar Recordings by Industry Experts

Contact the PSMA at APEC or at power@psma.com





The next roadmap cycle starts now



PTR Working Group Meeting

- Tuesday, Noon to 2pm
- Room 32, Convention Center





Thank you !

Emerging Technologies

Brian Narveson Ed Herbert Noah Sturcken Reza Azizian Doug Hopkins Haotao Ke

With support from

Dhaval Dalal lar Aung Thet Tu Joe Horzepa Lisa Horzepa Laurie House Greg Evans Mikhail Guz Kevin Parmenter Chuck Richardson PSMA Technical Committees And >100 Survey Responses

Product Trends

Alain Chapuis Brian Zahnstecher Ed Massey Stephen Oliver John Wiggenhorn Cahit Gezgin Jeff Nilles Arnold Alderman Ian Mazsa

Application Trends

Ajay Hari Chris Jones Upal Sengupta John Vigars Richard Caubang Maeve Duffy Michael Hayes Anandan Velayutham Prakash Shahi Yong Ann Ang Frazier Pruett Jim Young Brian Zahnstecher

Component Technologies \

Vittorio Crisafulli Tim McDonald Chris Bull Davide Chiola Michael Treu Johannes Schoiswohl Christophe Basso Prasad Venkatraman Tirthajyoti Sarkar Jeff Casady Ritu Sodhi Ali Salih Conor Quinn

Webinars

Ray Ridley Brian Narveson Siamak Abedinpour Michael Hayes Lorandt Fölkel Ajinder Singh Alex Huang Stephen Oliver Hans Stork Brian O'Connell Jeff Casady James Lewis **Ralph Kerrigan** Pierre Lohrber Reza Azizian Mark Cantrell Ravi Bhatkal